SP782/784

Programmable Charge Pump

- +5V Only Low Power Voltage Conversion
- Programmable Between ±5V or ±10V
- Low Power Shutdown Mode

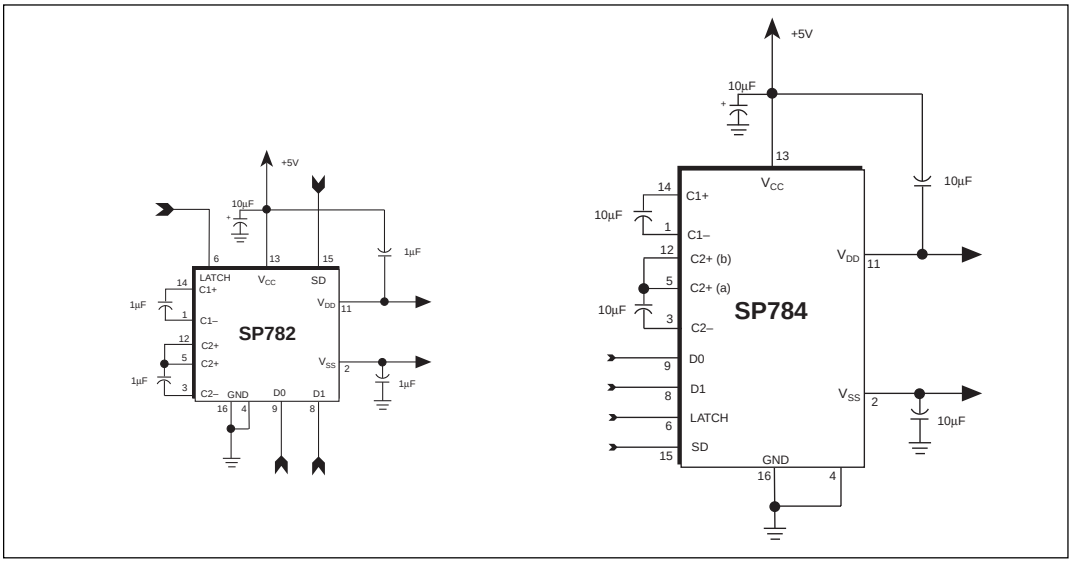
Applications

- RS-232/RS-423 transceiver power supplies
- LCD BIAS Generator
- OP-Amp Power Supplies

DESCRIPTION...

The **SP782** and **SP784** are monolithic programmable voltage converters that produce a positive and negative voltage from a single supply. The **SP782** and **SP784** are programmable such that the charge pump outputs either a ±10V voltage or a ±5V voltage by control of two pins. Both products require four (4) charge pump capacitors to support the resulting output voltages. The charge pump architecture (U.S. 5,760,637) is fabricated using a low power BiCMOS process technology.

The **SP782** and **SP784** charge pumps can be powered from a single +5V supply. The low power consumption makes these charge pumps ideal for battery operated equipment. Both offer a shutdown feature that saves battery life. A system can essentially have four (4) different supply voltages from a single battery. Typical applications are handheld instruments, notebook and laptop computers, and data acquisition systems.



 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{CC}.....+7V
V_{DD}.....+11V
V_{SS}.....–11V
Storage Temperature.....-65˚C to +150˚C
Power Dissipation
16-pin Plastic DIP.....1000mW
16-pin Plastic SOIC.....1000mW

Package Derating:
16-pin Plastic DIP
$ø_{JA}$.....62 °C/W
16-pin Plastic SOIC
$ø_{JA}$.....62 °C/W

SP782 SPECIFICATIONS

Typical @ 25°C and $V_{CC} = V_{CC} \pm 5\%$ unless otherwise noted.

	MIN.	TYP.	MAX.	UNITS	CONDITIONS
SUPPLY CURRENT					**CHARGE PUMP CAPACITORS: 1µF**
I_{CC}		3	8	mA	V_{CC} = +5V, $R_L = \infty$, $V_O = 2xV_{CC}$
		1	2	mA	V_{CC} = +5V, $R_L = \infty$, $V_O = V_{CC}$
Shutdown I_{CC}		10	25	µA	V_{CC} = +5V, SD = V_{CC}
POSITIVE CHARGE PUMP OUTPUT					**CHARGE PUMP CAPACITORS: 1µF**
V_{DD} ($2xV_{CC}$ Output)	+9.5	+9.8	+10.0	Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V $R_L = \infty$
	+8.0	+8.5		Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V R_L = 1kΩ
V_{DD} (V_{CC} Output)	+4.2	+4.5	+5.0	Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ $R_L = \infty$
	+4.2	+4.5		Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ R_L = 1kΩ
NEGATIVE CHARGE PUMP OUTPUT					**CHARGE PUMP CAPACITORS: 1µF**
V_{SS} ($2xV_{CC}$ Output)	–9.5	–9.8	–10.0	Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V $R_L = \infty$
	–8.0	–8.5		Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V R_L = 1kΩ
V_{SS} ($–V_{CC}$ Output)	–4.2	–4.5	–5.0	Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ $R_L = \infty$
	–4.0	–4.2		Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ R_L = 1kΩ
OSCILLATOR FREQUENCY					
f_{OSC}		300		kHz	SD = 0V
VOLTAGE CONVERSION EFFICIENCY					
V_{DD} (2X V_{CC} Output)	95	98		%	$R_L = \infty$
V_{DD} (2X V_{CC} Output)	80	85		%	R_L = 1kΩ
V_{SS} (2X V_{CC} Output)	85	90		%	$R_L = \infty$
V_{SS} (2X V_{CC} Output)	80	85		%	R_L = 1kΩ
POWER REQUIREMENTS					
V_{CC}	+4.75		+5.25	Volts	
ENVIRONMENTAL AND MECHANICAL					
Operating Temperature Range	0		+70	°C	
Storage Temperature Range	–65		+150	°C	

© Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{CC}.....+7V
V_{DD}.....+11V
V_{SS}.....–11V
Storage Temperature.....-65˚C to +150˚C
Power Dissipation
16-pin Plastic DIP.....1000mW
16-pin Plastic SOIC.....1000mW

Package Derating:
16-pin Plastic DIP
$ø_{JA}$.....62 °C/W
16-pin Plastic SOIC
$ø_{JA}$.....62 °C/W

SP784 SPECIFICATIONS

Typical @ 25°C and $V_{CC} = V_{CC} \pm 5\%$ unless otherwise noted.

	MIN.	TYP.	MAX.	UNITS	CONDITIONS
SUPPLY CURRENT					**CHARGE PUMP CAPACITORS: 10µF**
I_{CC}		5	10	mA	V_{CC} = +5V, $R_L = \infty$, $V_O = 2xV_{CC}$
		1	5	mA	V_{CC} = +5V, $R_L = \infty$, $V_O = V_{CC}$
Shutdown I_{CC}		10	25	µA	V_{CC} = +5V, SD = V_{CC}
POSITIVE CHARGE PUMP OUTPUT					**CHARGE PUMP CAPACITORS: 10µF**
V_{DD} ($2xV_{CC}$ Output)	+9.0	+9.8	+10.0	Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V $R_L = \infty$
	+8.0	+9.5		Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V R_L = 1kΩ
V_{DD} (V_{CC} Output)	+4.5	+4.8	+5.0	Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ $R_L = \infty$
	+4.2	+4.5		Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ R_L = 1kΩ
NEGATIVE CHARGE PUMP OUTPUT					**CHARGE PUMP CAPACITORS: 10µF**
V_{SS} ($2xV_{CC}$ Output)	–9.0	–9.8	–10.0	Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V $R_L = \infty$
	–8.0	–9.5		Volts	V_{CC} = +5V, D_0 = 0V, D_1 = 0V R_L = 1kΩ
V_{SS} ($–V_{CC}$ Output)	–4.2	–4.5	–5.0	Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ $R_L = \infty$
	–4.0	–4.2		Volts	V_{CC} = +5V, $D_0 = V_{CC}$, $D_1 = V_{CC}$ R_L = 1kΩ
OSCILLATOR FREQUENCY					
f_{OSC}		300		kHz	SD = 0V
VOLTAGE CONVERSION EFFICIENCY					
V_{DD} (2X V_{CC} Output)	90	98		%	$R_L = \infty$
V_{DD} (2X V_{CC} Output)	80	95		%	R_L = 1kΩ
V_{SS} (2X V_{CC} Output)	90	98		%	$R_L = \infty$
V_{SS} (2X V_{CC} Output)	80	95		%	R_L = 1kΩ
POWER REQUIREMENTS					
V_{CC}	+4.75		+5.25	Volts	
ENVIRONMENTAL AND MECHANICAL					
Operating Temperature Range	0		+70	°C	
Storage Temperature Range	–65		+150	°C	

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

AC CHARACTERISTICS*

(Typical @ 25°C and nominal supply voltages unless otherwise noted)

PARAMETER	MIN.	TYP.	MAX.	UNITS	CONDITIONS
SP782 POWER-UP DELAY TIME					
±10V OUTPUT					
t_{DVDD}; V_{DD} Power On Delay		1000		µs	R_L = 1kΩ
t_{DVSS}; V_{SS} Power-On Delay		1000		µs	R_L = 1kΩ
±5V OUTPUT					
t_{DVDD}; V_{DD} Power On Delay		10		µs	R_L = 1kΩ
t_{DVSS}; V_{SS} Power-On Delay		150		µs	R_L = 1kΩ
SP782 OUTPUT DELAY TIME					
t_{SD1}; Switching Delay from ±10V to ±5V		1000		µs	R_L = 1kΩ
t_{SD2}; Switching Delay from ±5V to ±10V		500		µs	R_L = 1kΩ
SP784 POWER-UP DELAY TIME					
±10V OUTPUT					
t_{DVDD}; V_{DD} Power On Delay		5		ms	R_L = 1kΩ
t_{DVSS}; V_{SS} Power-On Delay		5		ms	R_L = 1kΩ
±5V OUTPUT					
t_{DVDD}; V_{DD} Power On Delay		10		µs	R_L = 1kΩ
t_{DVSS}; V_{SS} Power-On Delay		1000		µs	R_L = 1kΩ
SP784 OUTPUT DELAY TIME					
t_{SD1}; Switching Delay from ±10V to ±5V		10		ms	R_L = 1kΩ
t_{SD2}; Switching Delay from ±5V to ±10V		2		ms	R_L = 1kΩ

* - Using the charge pump capacitor values specified in the previous pages for each device.

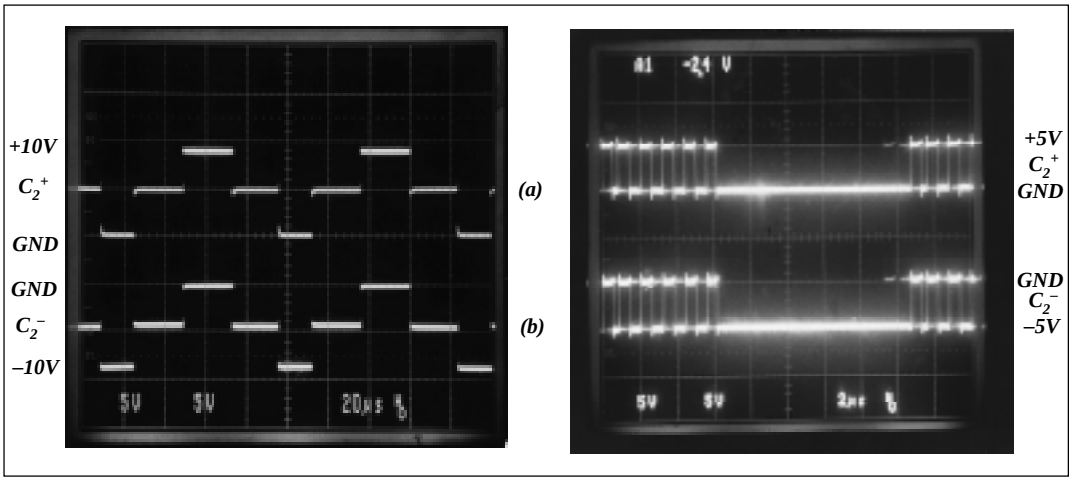
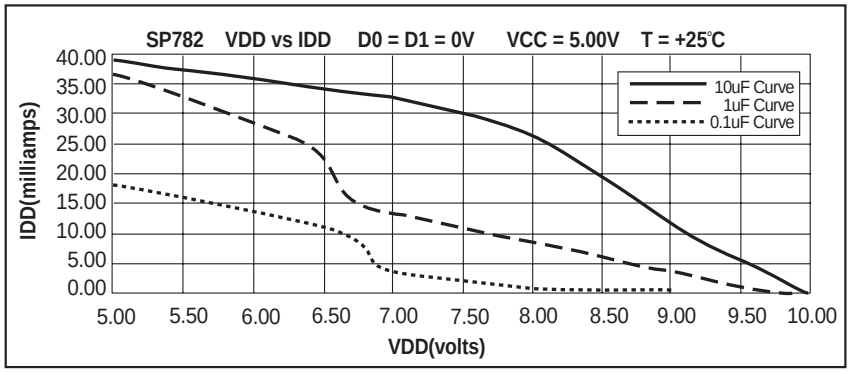
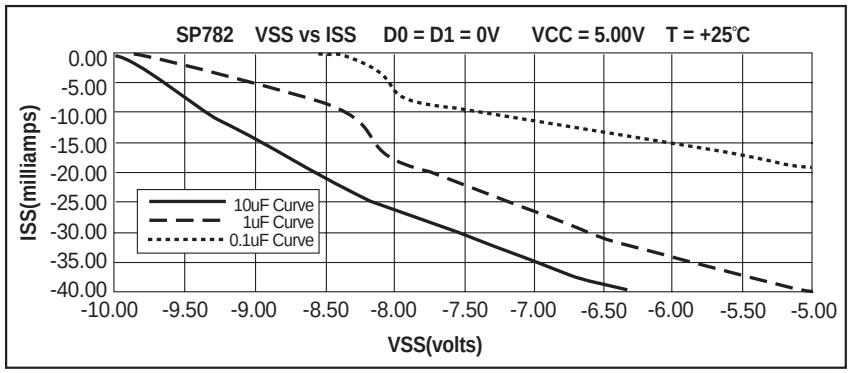


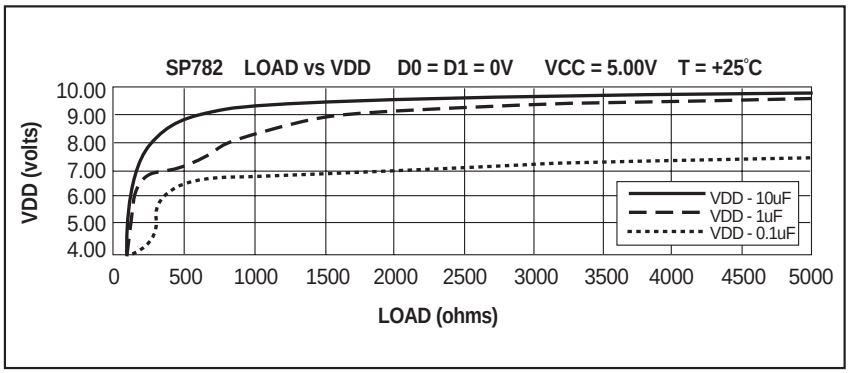
Figure 1. Charge Pump Waveforms

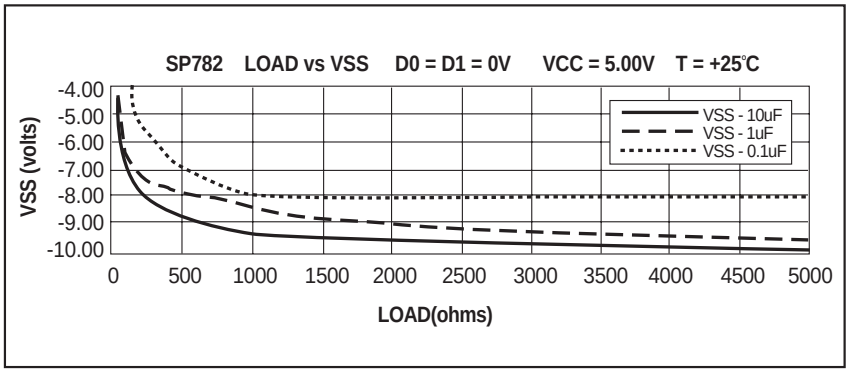
 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor



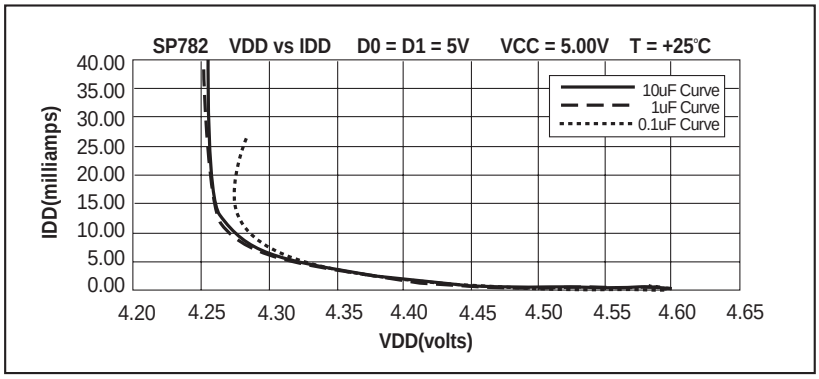


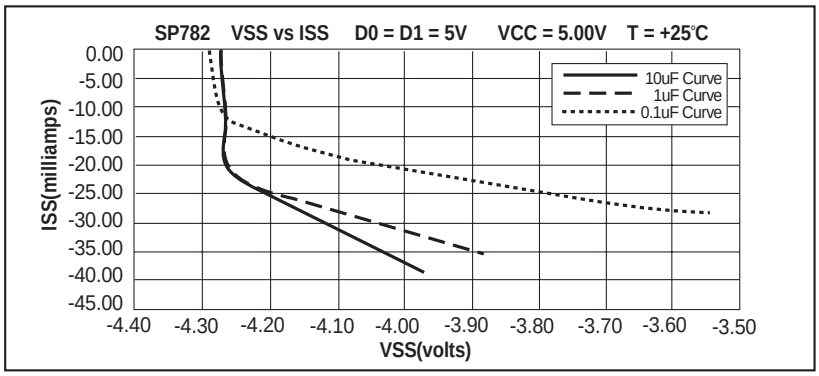


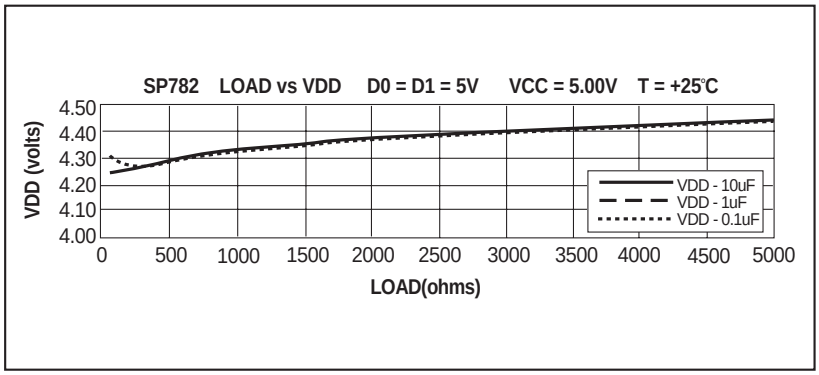


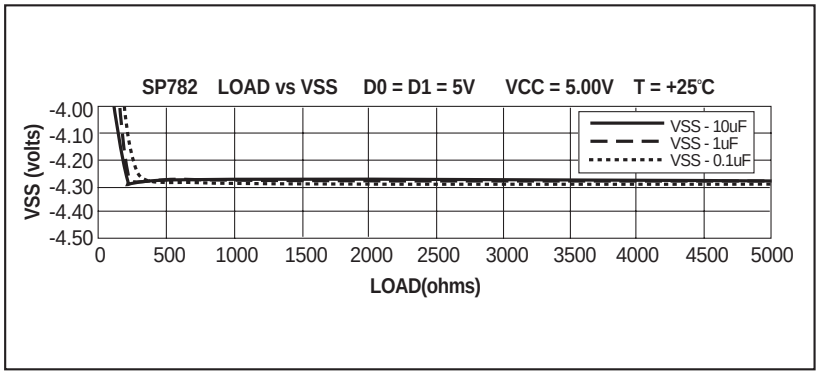
 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor



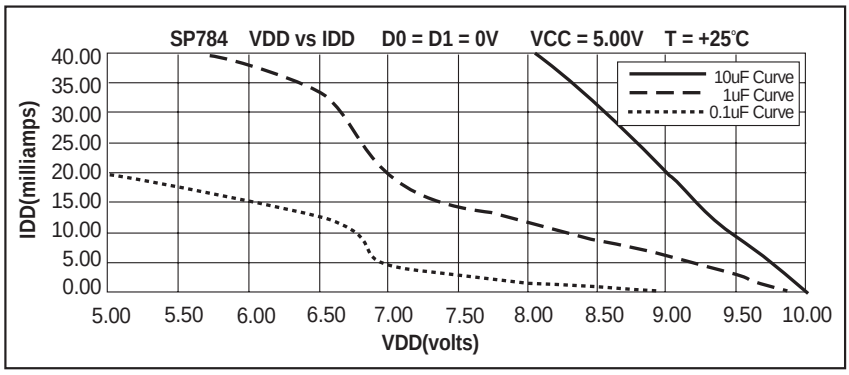


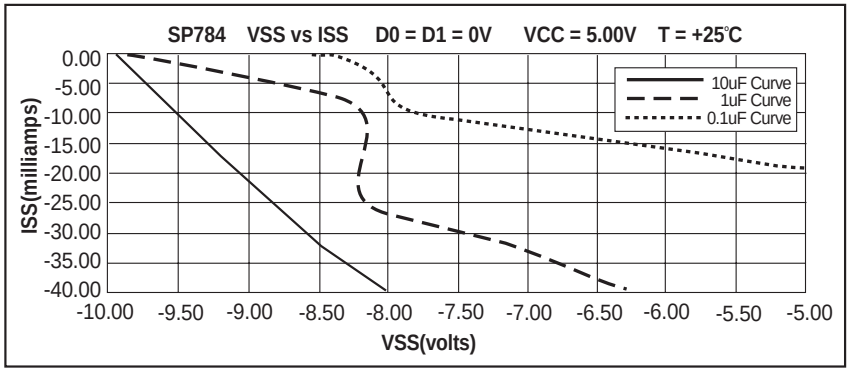


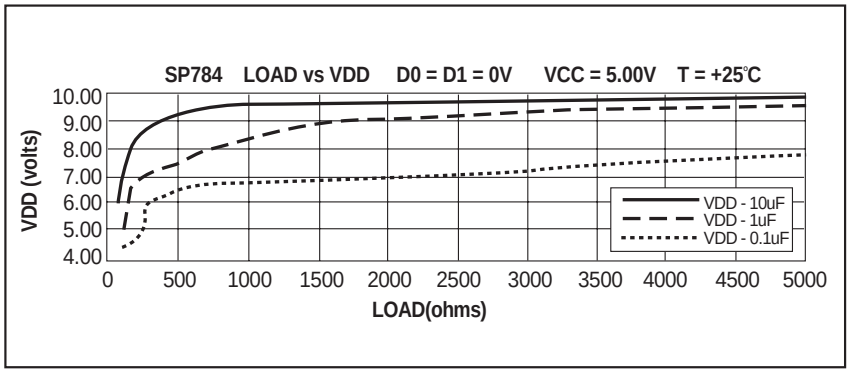


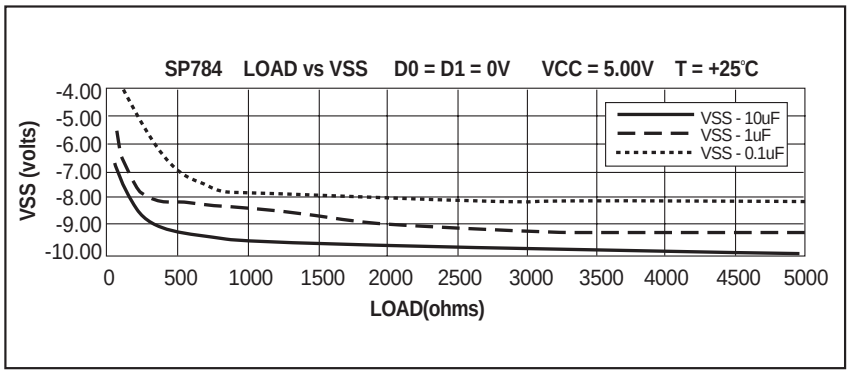
 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor



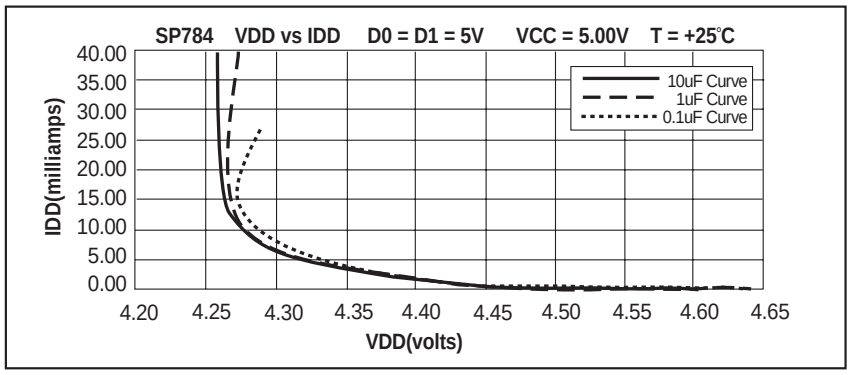


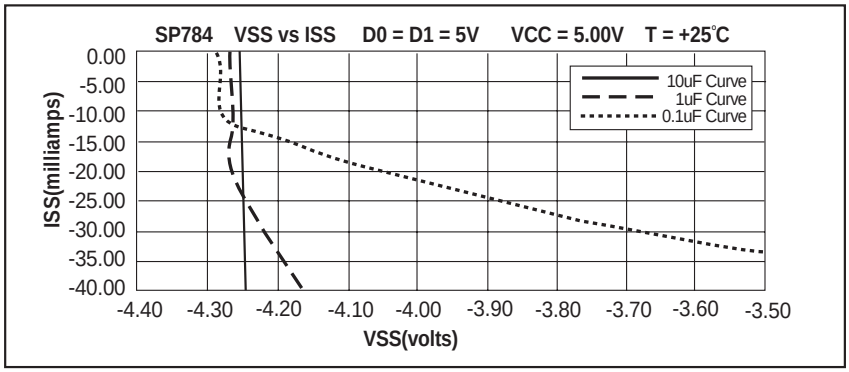


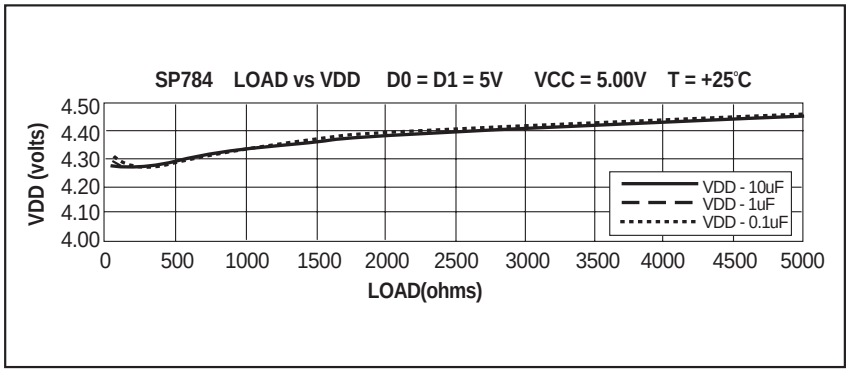


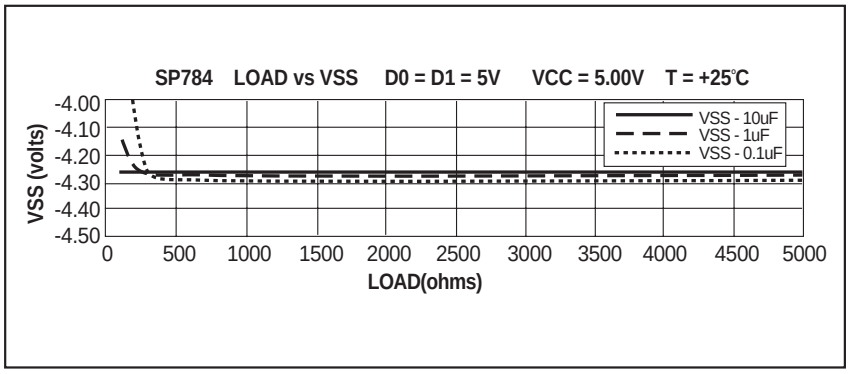
 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor









 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

THEORY OF OPERATION

The **SP782/784's** charge pump design is based on **Sipex's** original patented charge pump design (5,306,954) which uses a four–phase voltage shifting technique to attain symmetrical 10V power supplies. In addition, the **SP782/784** charge pump incorporates a "programmable" feature that produces an output of ±10V or ±5V for V_{SS} and V_{DD} by two control pins, D0 and D1. The charge pump requires external capacitors to store the charge. Figure 1 shows the waveform found on the positive and negative side of capcitor C2. There is a free–running oscillator that controls the four phases of the voltage shifting. A description of each phase follows.

Phase 1 (±10V)

— V_{SS} charge storage — During this phase of the clock cycle, the positive side of capacitors C_1 and C_2 are initially charged to +5V. C_1^+ is then switched to ground and the charge on C_1^- is transferred to C_2^-. Since C_2^+ is connected to +5V, the voltage potential across capacitor C_2 is now 10V.

Phase 1 (±5V)

— V_{SS} & V_{DD} charge storage and transfer — With the C_1 and C_2 capacitors initially charged to +5V, C_1^+ is then switched to ground and the charge on C_1^- is transferred to the V_{SS} storage capacitor. Simultaneously the C_2^- is switched to ground and 5V charge on C_2^+ is transferred to the V_{DD} storage capacitor.

Phase 2 (±10V)

— V_{SS} transfer — Phase two of the clock connects the negative terminal of C_2 to the V_{SS} storage capacitor and the positive terminal of C_2 to ground, and transfers the generated –l0V or the generated –5V to C_3. Simultaneously, the positive side of capacitor C_1 is switched to +5V and the negative side is connected to ground.

Phase 2 (±5V)

— V_{SS} & V_{DD} charge storage — C_1^+ is reconnected to V_{CC} to recharge the C_1 capacitor. C_2^+ is switched to ground and C_2^- is connected to C_3. The 5V charge from Phase 1 is now transferred to the V_{SS} storage capacitor. V_{SS} receives a continuous charge from either C_1 or C_2. With the C1 capacitor charged to 5V, the cycle begins again.

Phase 3

— V_{DD} charge storage — The third phase of the clock is identical to the first phase — the charge transferred in C_1 produces –5V in the negative terminal of C_1, which is applied to the negative side of capacitor C_2. Since C_2^+ is at +5V, the voltage potential across C_2 is l0V. For the 5V output, C_2^+ is connected to ground so that the potential on C_2 is only +5V.

Phase 4

— V_{DD} transfer — The fourth phase of the clock connects the negative terminal of C_2 to ground and transfers the generated l0V or the generated 5V across C_2 to C_4, the V_{DD} storage capacitor. Again, simultaneously with this, the positive side of capacitor C_1 is switched to +5V and the negative side is connected to ground, and the cycle begins again.

Since both V_{DD} and V_{SS} are separately generated from V_{CC} in a no–load condition, V_{DD} and V_{SS} will be symmetrical. Older charge pump approaches that generate V^- from V^+ will show a decrease in the magnitude of V^- compared to V^+ due to the inherent inefficiencies in the design.

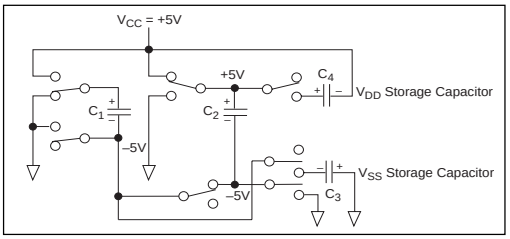


Figure 2. Charge Pump Phase 1 for ±10V.

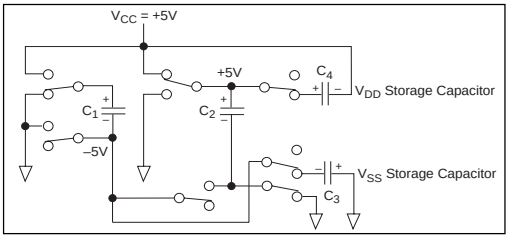


Figure 3. Charge Pump Phase 1 for ±5V.

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

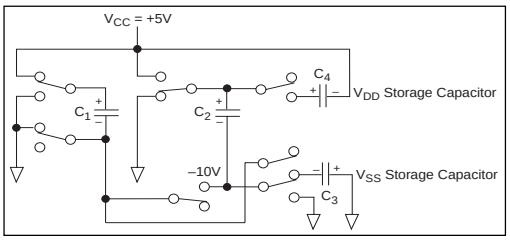


Figure 4. Charge Pump Phase 2 for ±10V.

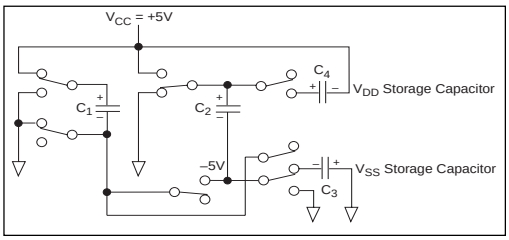


Figure 5. Charge Pump Phase 2 for ±5V.

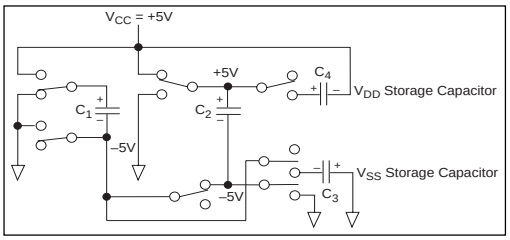


Figure 6. Charge Pump Phase 3.

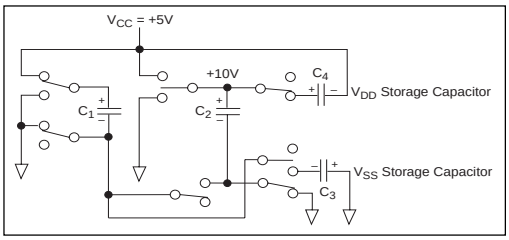


Figure 7. Charge Pump Phase 4.

The oscillator frequency or clock rate for the charge pump is designed for low power operation. The oscillator changes from a high frequency mode (400kHz) to a low frequency mode (20kHz) when the SD pin goes to a logic "1". The lower frequency allows the **SP782/ SP784** to conserve power when the outputs are not being used.

EFFICIENCY INFORMATION

A charge pump theoretically produces a doubled voltage at 100% efficiency. However in the real world, there is a small voltage drop on the output which reduces the output efficiency. The **SP782** and **SP784** can usually run 99.9% efficient without driving a load. While driving a 1kΩ load, the **SP782** and **SP784** remain at least 90% efficient.

Total Output Voltage Efficiency =

$[(V_{OUT}+) / (2*V_{CC})] + [(V_{OUT}–) / (–2*V_{CC})]$;

$V_{OUT}+ = 2*V_{CC} + V_{DROP}+$

$V_{OUT}– = –2*V_{CC} + V_{DROP}–$

$V_{DROP}– = (I–)*(R_{OUT}–)$

$V_{DROP}+ = (I+)*(R_{OUT}+)$

Power Loss = $I_{OUT}*(V_{DROP})$

The efficiency changes as the external charge pump capacitors are varied. Larger capacitor values will strengthen the output and reduce output ripple usually found in all charge pumps. Although smaller capacitors will cost less and save board space, lower values will reduce the output drive capability.

The output voltage ripple is also affected by the capacitors, specifically C3 and C4. Larger values will reduce the output ripple for a given load of current. The current drawn from either output is supplied by just the storage capacitor, C3 or C4, during one half cycle of the internal oscillator. Note that the output current from the postive charge pump is the load current plus the current taken by the negative charge pump. Thus the formula representation for the output ripple voltage is:

$V_{RIPPLE}+ = \{1 / (f_{OSC}) * 1 / C3\} * 0.5 * I_{OUT}+$

$V_{RIPPLE}– = \{1 / (f_{OSC}) * 1 / C3\} * 0.5 * I_{OUT}–$

To minimize the output ripple, the C3 and C4 storage capacitors can be increased to over 10µF whereas the pump capacitors can range from 1µF to 5µF.

Multiple **SP782/784** charge pumps can be connected in parallel. However, the output resistance on both pump outputs will be reduced. The effective output resistance is the output resistance of one pump divided by the number of charge pumps connected. It is important to keep the C1 and C2 capacitors separate for each charge pump. The storage capacitors, C3 and C4, can be shared.

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

SHUTDOWN MODE

The internal oscillator of the **SP782** and **SP784** can be shutdown through the SD pin. In this state, the V_{DD} and V_{SS} outputs are inactive and the power supply current reduces to 10µA.

LATCH ENABLE PIN

The **SP782** and **SP784** includes a control pin (LAT) that latches the D0 and D1 control lines. Connecting this pin to a logic HIGH state will allow transparent operation of the D0 and D1 control lines. This input can be left floating since there is an internal pull-up resistor which will allow the latch to be transparent.

APPLICATIONS INFORMATION

The **SP782** and **SP784** can be used in various applications where ±10V is needed from a +5V source. Analog switches, op-amp power supplies, and LCD biasing are some applications where the charge pumps can be used.

The charge pump can also be used for supplying voltage rails for RS-232 drivers needing ±12V. The ±10V output from the charge pump is more than adequate to provide the proper V_{OH} and V_{OL} levels at the driver output.

Figure 8 shows how the **SP784** can be used in conjunction with the SP524 multiprotocol transceiver IC. The programmability is ideal for RS-232 and RS-423 levels. The RS-232 driver output voltage swing ranges from ±5V to ±15V. In order to meet this requirement, the charge pump must generate ±10V to the transceiver IC.

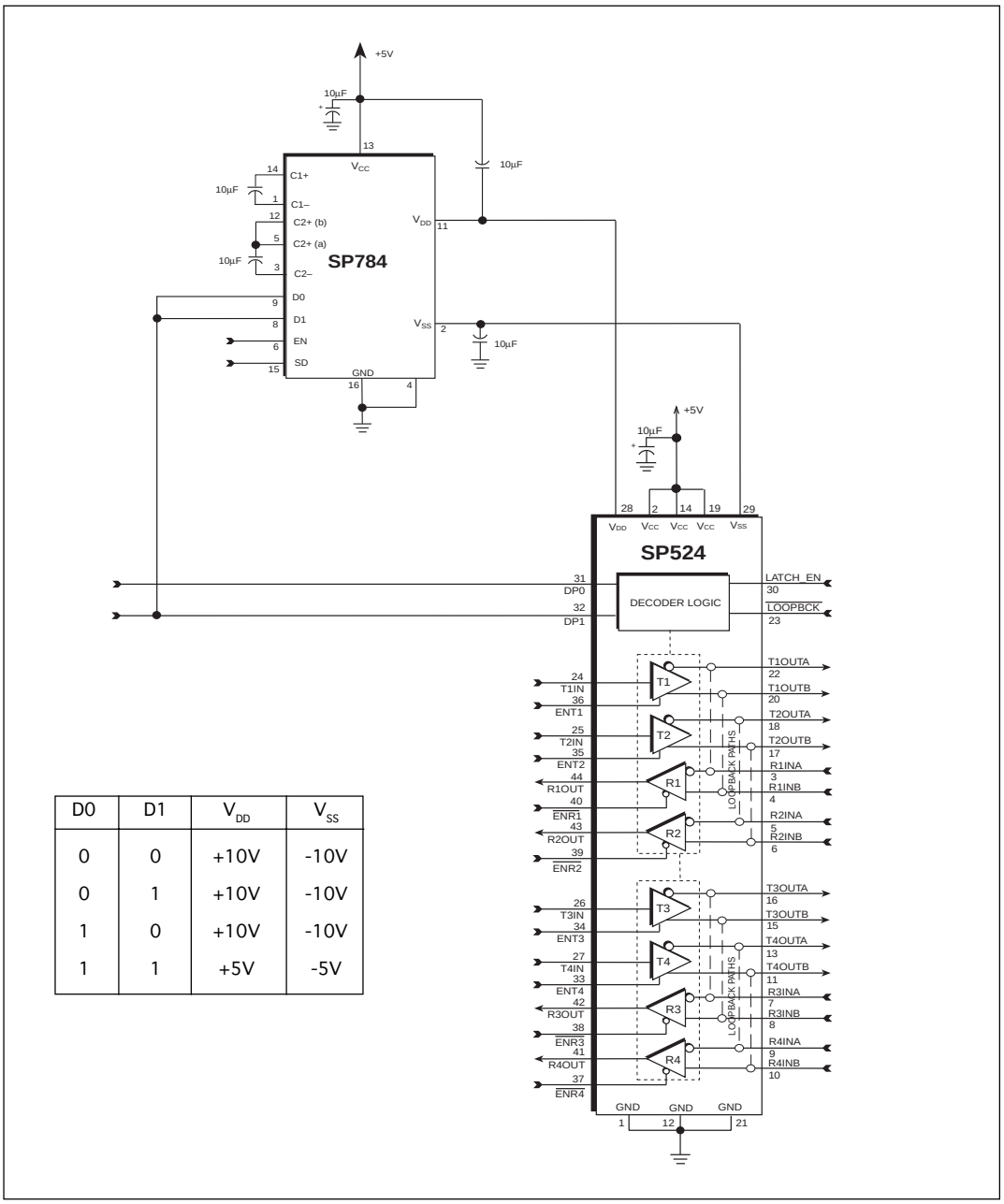
The RS-423 driver output voltage range is ±4.0V to ±6.0V. When the SP524 transceiver is programmed to RS-423 mode (V.10), the charge pump now provides ±5V, through D0 and D1, thus allowing the driver outputs to comply with $V_{OC} \leq 6.0V$ as well as the V_T requirement of ±4.0V minimum with a 450Ω load to ground.

In older configurations, separate DC sources needed to be configured or regulated down from ±10V to ±5V in a given application. A typical charge pump providing V_{DD} and V_{SS} would require external clamping such as 5V Zener diodes. RS-423 (V.10) is usually found in RS-449, EIA-530, EIA-530A, and V.36 modes.

When the control lines D0 and D1 are both at a logic HIGH, V_{DD} = +5V and V_{SS} = -5V. All other inputs to the control lines result in V_{DD} = +10V and V_{SS} = -10V. Control of the **SP784** in an application with **Sipex's SP524** can be found in *Figure 8*.

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor



D0	D1	V_{DD}	V_{SS}
0	0	+10V	-10V
0	1	+10V	-10V
1	0	+10V	-10V
1	1	+5V	-5V

Figure 8. SP784 Application w/ SP524 Multi-Protocol Transceiver IC.

Downloaded from Elcodis.com electronic components distributor

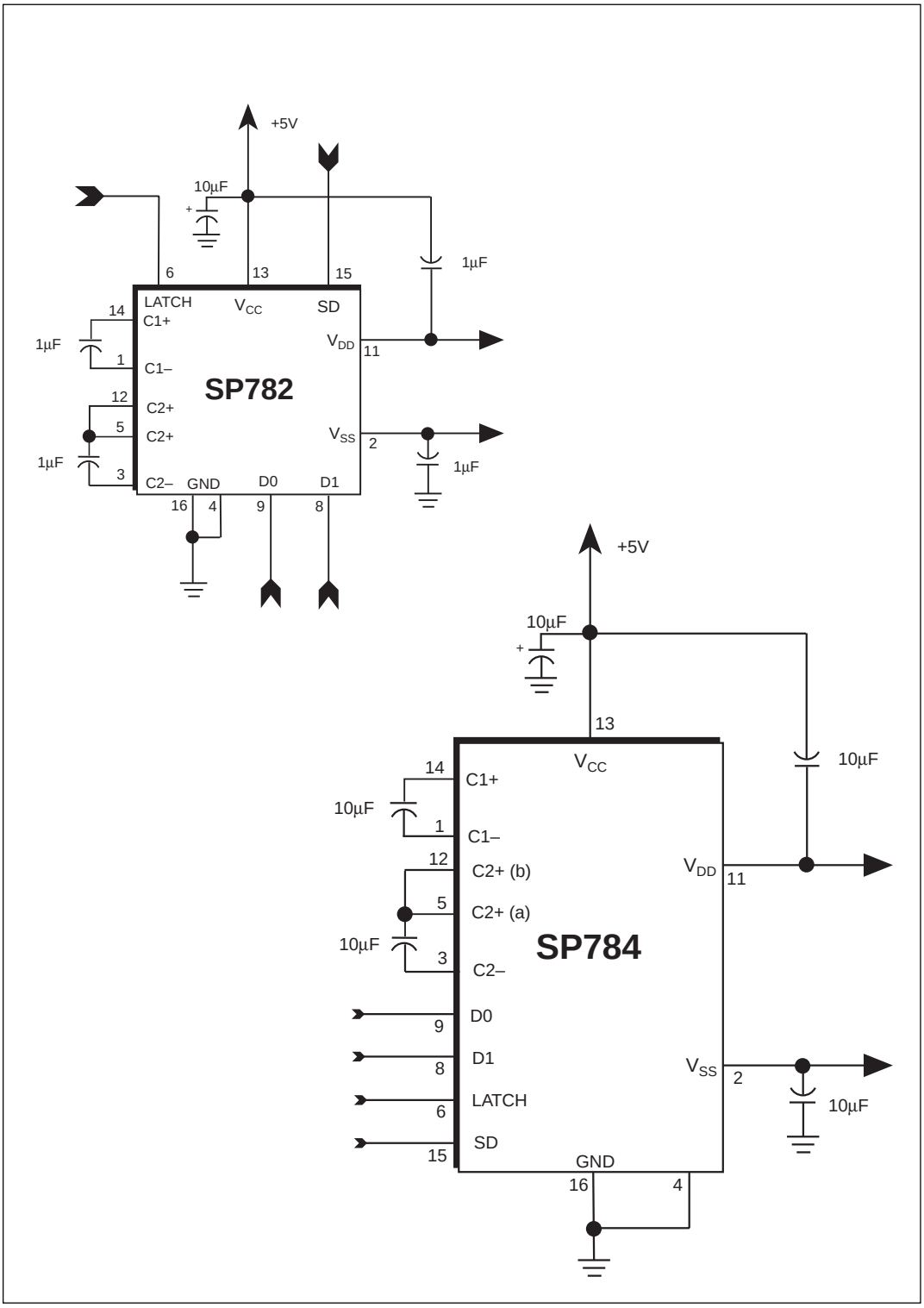
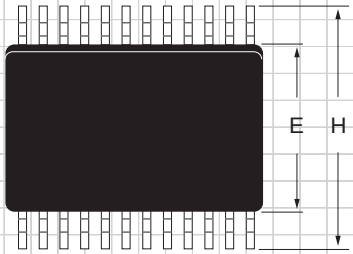


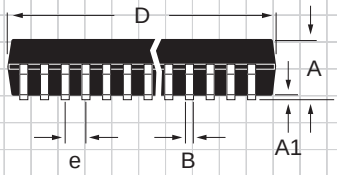
Figure 9. SP782 and SP784 Block Diagrams

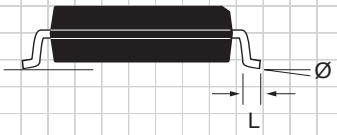
 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

PACKAGE: PLASTIC SMALL OUTLINE (SOIC) (WIDE)





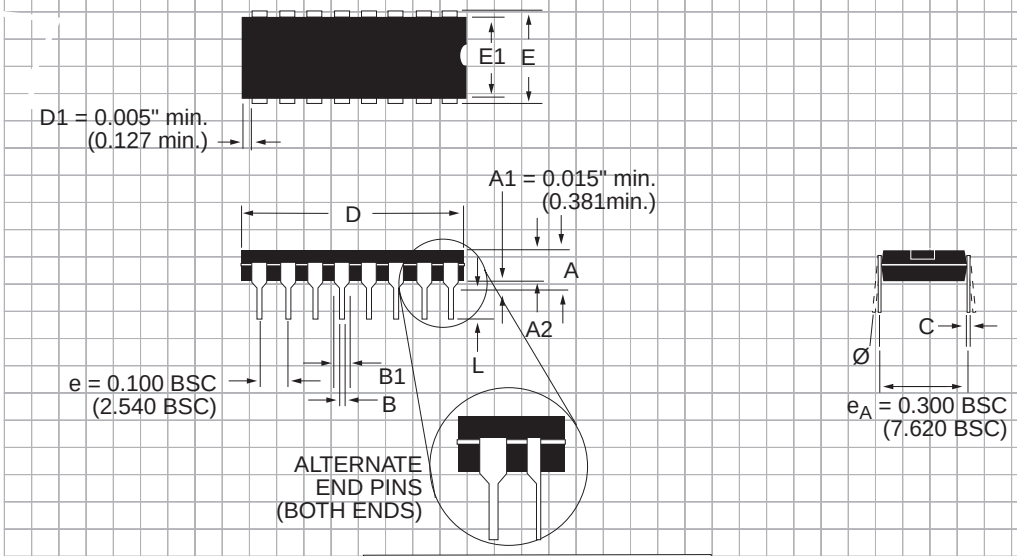


DIMENSIONS (Inches) Minimum/Maximum (mm)	16–PIN
A	0.093/0.104 (2.352/2.649)
A1	0.004/0.012 (0.102/0.300)
B	0.013/0.020 (0.330/0.508)
D	0.398/0.406 (10.11/10.31)
E	0.291/0.299 (7.402/7.600)
e	0.050 BSC (1.270 BSC)
H	0.394/0.419 (10.00/10.64)
L	0.016/0.050 (0.406/1.270)
Ø	0°/8° (0°/8°)

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

PACKAGE: 16-PIN PLASTIC DUAL–IN–LINE (NARROW)



DIMENSIONS (Inches) Minimum/Maximum (mm)	16–PIN
A	–/0.210 (–/5.334)
A2	0.115/0.195 (2.921/4.953)
B	0.014/0.022 (0.356/0.559)
B1	0.045/0.070 (1.143/1.778)
C	0.008/0.014 (0.203/0.356)
D	0.780/0.800 (19.812/20.320)
E	0.300/0.325 (7.620/8.255)
E1	0.240/0.280 (6.096/7.112)
L	0.115/0.150 (2.921/3.810)
Ø	0°/ 15° (0°/15°)

 © Copyright 2000 Sipex Corporation

Downloaded from Elcodis.com electronic components distributor

ORDERING INFORMATION

Model	Temperature Range	Package Types
SP782CP	0°C to +70°C	16-pin Plastic DIP
SP784CP	0°C to +70°C	16-pin Plastic DIP
SP782CT	0°C to +70°C	16-pin SOIC
SP784CT	0°C to +70°C	16-pin SOIC

Please consult the factory for pricing and availability on a Tape-On-Reel option.

SIGNAL PROCESSING EXCELLENCE

Sipex Corporation

Headquarters and
Sales Office
22 Linnell Circle
Billerica, MA 01821
TEL: (978) 667-8700
FAX: (978) 670-9001
e-mail: sales@sipex.com

Sales Office
233 South Hillview Drive
Milpitas, CA 95035
TEL: (408) 934-7500
FAX: (408) 935-7600

Sipex Corporation reserves the right to make changes to any products described herein. Sipex does not assume any liability arising out of the application or use of any product or circuit described hereing; neither does it convey any license under its patent rights nor the rights of others.

Downloaded from Elcodis.com electronic components distributor